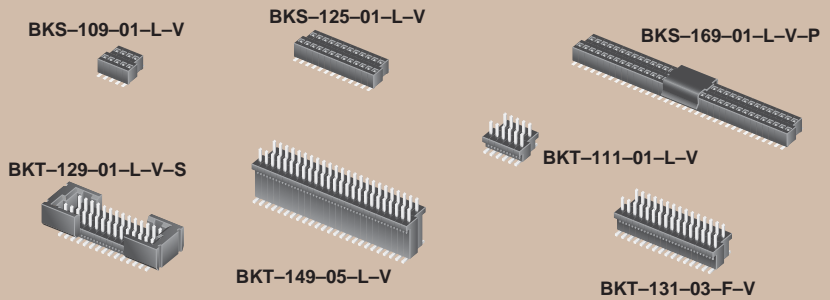


(1,00mm) .03937"

BKT, BKS SERIES



POLARIZED MICRO HEADER & SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?BKT or www.samtec.com?BKS

Insulator Material:

Liquid Crystal Polymer



Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over 50µ" (1,27µm) Ni

Current Rating:

1.5A @ 80°C ambient

Operating Temp Range:

-55°C to +125°C

Contact Resistance:

15 mΩ max

Insertion Depth:

(1,40mm) .055" minimum

Insertion Force:

(Single contact only) 1.5oz (0,42N) average

Normal Force:

40 grams (0,39N) average

Withdrawal Force:

(Single contact only) .75oz (0,20N) average

Max Cycles:

100 with 10µ" (0,25µm) Au

RoHS Compliant:

Yes

Processing:

Lead-Free Solderable: Yes

SMT Lead Coplanarity: (0,10mm) .004" max

BKT - **1** **NO. OF POSITIONS** - **BASE HEIGHT** - **PLATING OPTION** - **V** - **OPTIONS**

Mates with: **BKS**

07 thru 69
(Odd lead counts only)

Specify **BODY STYLE** from chart

BODY STYLE	BASE HEIGHT H	BOARD SPACE (mated with BKS)
-01	(1,93) .076	(4,14) .163
-02	(2,29) .090	(4,50) .177
-03	(2,79) .110	(5,00) .197
-04	(3,78) .149	(6,00) .236
-05	(4,80) .189	(7,00) .276

-F = Gold flash on post, Matte Tin on tail

-L = 10µ" (0,25µm) Gold on post, Matte Tin on tail

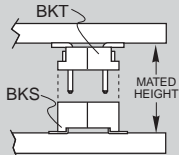
-S = Shrouded (15 positions minimum)

-A = Alignment Pin (Metal or plastic at Samtec discretion) (14 positions minimum)

-P = Pick & Place Pad (13 positions minimum)

-TR = Tape & Reel Packaging

APPLICATIONS



BKT LEAD STYLE	MATED HEIGHT*
-01	(4,14) .163
-02	(4,50) .177
-03	(5,00) .197
-04	(6,00) .236
-05	(7,00) .276

*Processing conditions will affect mated height.



Note: Some sizes, styles and options are non-standard, non-returnable.

BKS - **1** **NO. OF POSITIONS** - **01** - **PLATING OPTION** - **V** - **OPTIONS**

Mates with: **BKT**

07 thru 69
(07 positions available with -TR only)

-F = Pre-plated Gold flash on contact, Matte Tin on tail

-L = Pre-plated 10µ" (0,25µm) Gold contact, Matte Tin on tail

-A = Alignment Pin (Metal or plastic at Samtec discretion) (11 positions minimum)

-P = Pick and Place Pad (13 positions minimum) Not always necessary for auto placement. See Flex Processing.

-TR = Tape & Reel Packaging

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM